RoHS Available

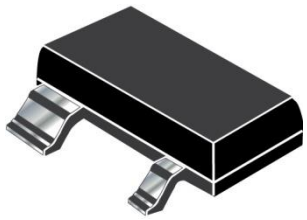
Unidirectional TVSarray

DESCRIPTION

This USB50403 – USB50424 Transient Voltage Suppressor (TVS) family is packaged in a SOT-143 configuration giving protection to 1 unidirectional data or interface line. It is designed for use in applications where protection is required at the board level from voltage transients caused by electrostatic discharge (ESD) as defined in IEC 61000–4-2, electrical fast transients (EFT) per IEC 61000-4-4, and secondary effects of lightning. It is also available in RoHS compliant versions.

These TVS arrays have a peak power rating of 500 watts for an 8/20 μsec pulse. This array is suitable for protection of sensitive circuitry consisting of TTL, CMOS, DRAM's, SRAM's, HCMOS, HSIC microprocessors, and Universal Serial Bus (USB) and I/O transceivers.

Important: For the latest information, visit our website http://www.microsemi.com.



SOT-143 Package

Also available in:

Bidirectional SOT-143
(surface mount)
USB50403C – USB50424C

FEATURES

- Protects 1 unidirectional line
- Surge protection per IEC 61000-4-2 and IEC 61000-4-4
- Provides electrically isolated protection
- UL 94V-0 flammability classification
- Ultra low capacitance, 3 pF per line pair
- Ultra low leakage
- RoHS compliant versions available

APPLICATIONS / BENEFITS

- EIA-RS485 data rates: 5 Mbs
- 10 Base T Ethernet
- USB data rate: 900 Mbs

MAXIMUM RATINGS

Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	T_J and T_{STG}	-55 to +150	°C
Peak Pulse Power @ 8/20 μs (see Figure 1)	P_{PP}	500	W
Impulse Repetition Rate	df	< 0.01	%
Total Capacitance (f = 1 MHz) @ 0 V	C_T	3	pF
Solder Temperature @ 10 s		260	°C

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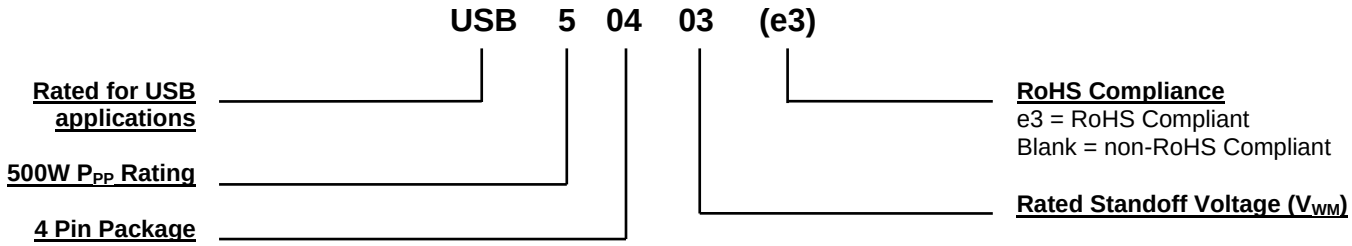
MECHANICAL and PACKAGING

- CASE: Molded SOT-143 surface mount
- TERMINALS: Tin-lead or RoHS compliant annealed matte-tin plating
- MARKING: See electrical characteristics table
- POLARITY: Pin #1 (Please refer to Schematic and Pad Layout for pin 1)
- TAPE & REEL option: Per EIA standard 481-1-A. Consult factory for quantities
- WEIGHT: Approximately 0.035 grams
- See Package Dimensions on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS

Symbol	Definition
$\alpha_{V(BR)}$	Temperature Coefficient of Breakdown Voltage: The change in breakdown voltage divided by the change in temperature that caused it expressed in %/°C or mV/°C.
C_T	Total Capacitance: The total small signal capacitance between the diode terminals of a complete device.
I_D	Standby Current: The current through the device at rated stand-off voltage.
$V_{(BR)}$	Breakdown Voltage: The voltage across the device at a specified current $I_{(BR)}$ in the breakdown region.
V_C	Clamping Voltage: The voltage across the device in a region of low differential resistance during the application of an impulse current (I_{PP}) for a specified waveform.
V_{WM}	Working Standoff Voltage: The maximum-rated value of dc or repetitive peak positive cathode-to-anode voltage that may be continuously applied over the standard operating temperature.

ELECTRICAL CHARACTERISTICS

PART NUMBER	DEVICE MARKING*	STAND-OFF VOLTAGE V_{WM} Volts	BREAKDOWN VOLTAGE $V_{(BR)}$ @1 mA Volts	CLAMPING VOLTAGE V_C @ 1 Amp (Figure 2) Volts	CLAMPING VOLTAGE V_C @ 5 Amp (Figure 2) Volts	STANDBY CURRENT I_D @ V_{WM} µA	TOTAL CAPACITANCE (f= 1 MHz) C_T @ 0 V pF	TEMPERATURE COEFFICIENT OF $V_{(BR)}$ $\alpha_{V(BR)}$ mV/°C
		MAX	MIN	MAX	MAX	MAX	MAX	MAX
USB50403	5AA	3.3	4	8	11	200	3	-5
USB50405	5AB	5.0	6.0	10.8	13	20	3	1
USB50412	5AC	12.0	13.3	19	26	1	3	8
USB50415	5AD	15.0	16.7	24	32	1	3	11
USB50424	5AE	24.0	26.7	43	57	1	3	28

***** Device marking has a dot suffix for the e3 RoHS compliant option (e.g. 5AA●, 5AD●, etc.)

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GRAPHS

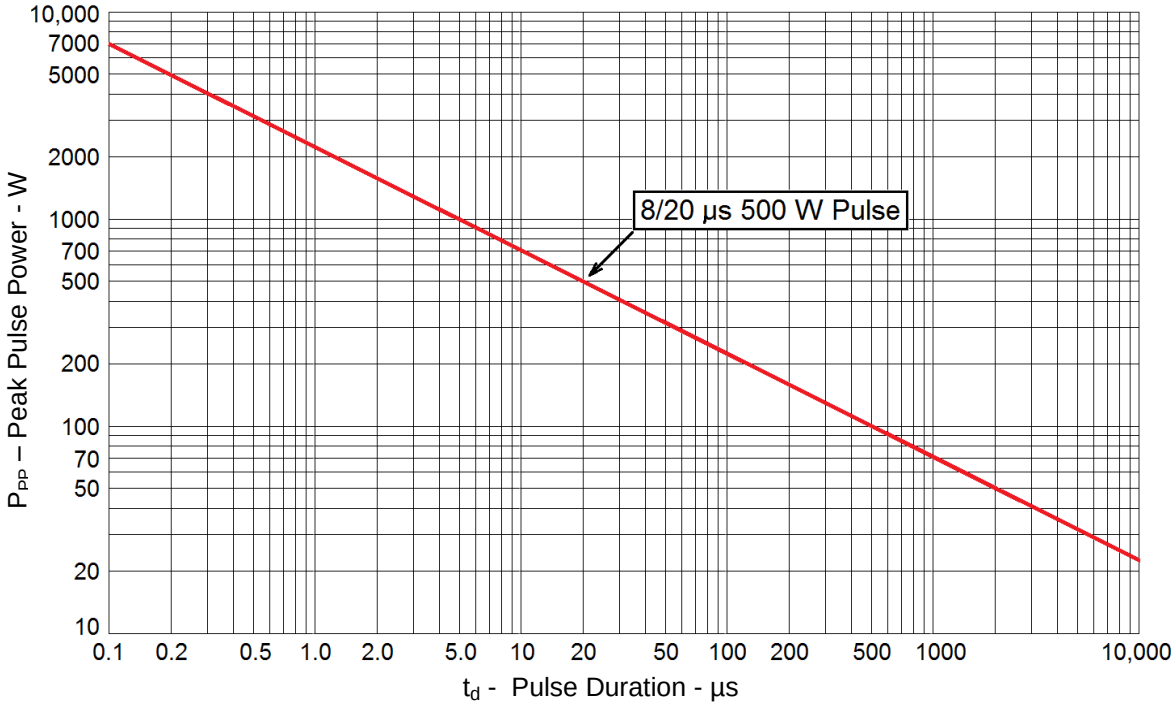

FIGURE 1
Peak Pulse Power vs Pulse Time

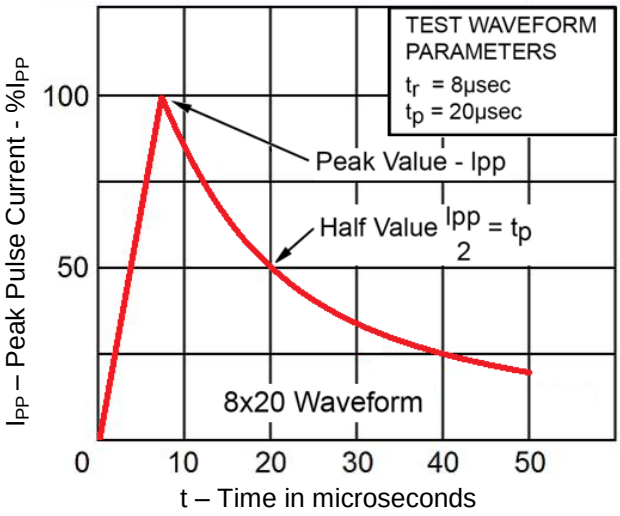

FIGURE 2
Pulse Waveform

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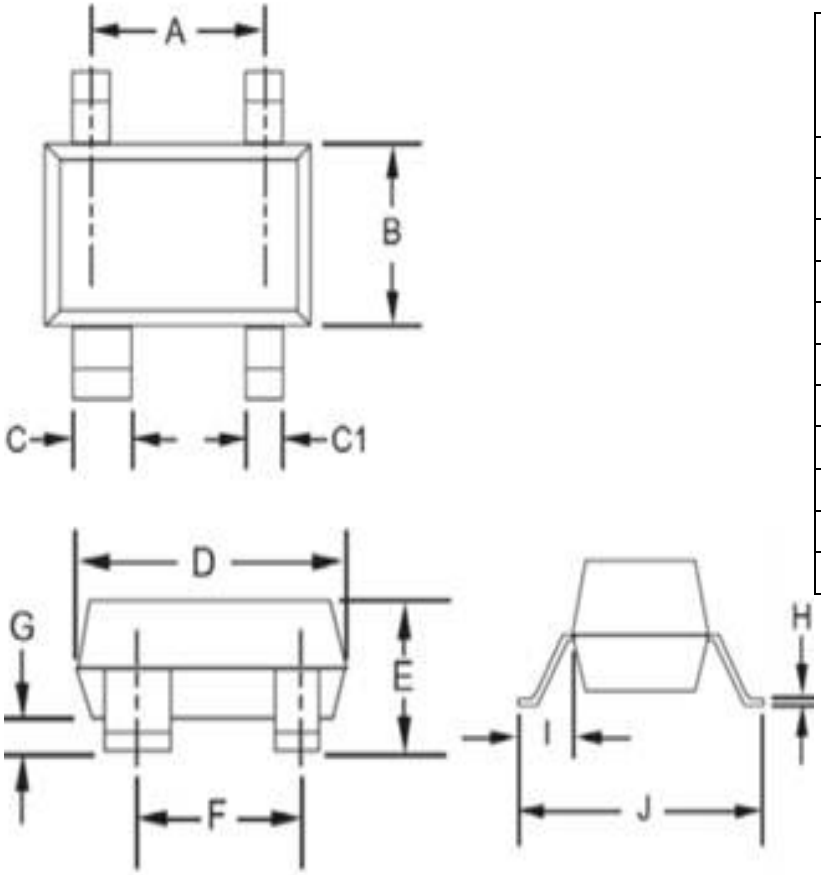
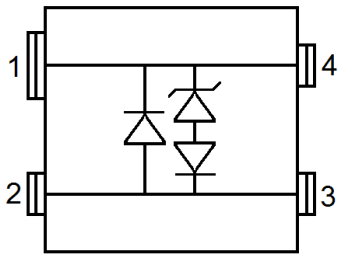
PACKAGE DIMENSIONS

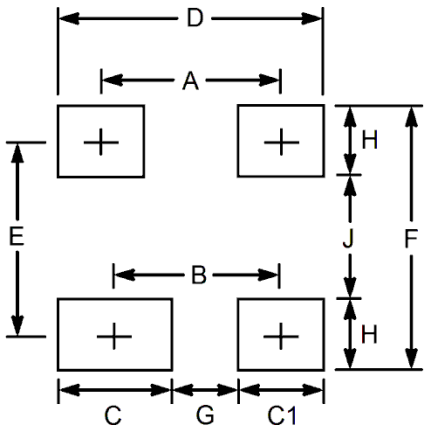


Ltr	Dimensions			
	Inch		Millimeters	
	Min	Max	Min	Max
A	0.0701	0.0807	1.78	2.05
B	0.047	0.055	1.20	1.40
C1	0.027	0.033	0.69	0.84
C1	0.012	0.018	0.30	0.46
D	0.107	0.113	2.72	2.87
E	0.042	0.045	1.07	1.14
F	0.067	0.079	1.70	2.01
G	0.002	0.008	0.051	0.2
H	0.003	0.009	0.076	0.23
I	0.018	0.023	0.46	0.58
J	0.083	0.093	2.11	2.36

SCHEMATIC and PAD LAYOUT



Schematic



Ltr	Dimensions	
	Inch	Millimeters
	Typ	Typ
A	0.079	2.00
B	0.071	1.80
C	0.047	1.20
C1	0.033	0.85
D	0.112	2.85
E	0.075	1.90
F	0.108	2.75
G	0.031	0.80
H	0.033	0.85
J	0.041	1.05

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